

KPHB-1608SYKSURKC-GX

1.6 x 0.8 x 0.5 mm Bi-Color Surface Mount LED



DESCRIPTIONS

- The Super Bright Yellow device is made with AlGaInP (on GaAs substrate) light emitting diode chip
- The Hyper Red source color devices are made with AlGaInP on GaAs substrate Light Emitting Diode
- Electrostatic discharge and power surge could damage the LEDs
- . It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs
- All devices, equipments and machineries must be electrically grounded

FEATURES

- 1.6 x 0.8 mm SMD LED, 0.5 mm thickness
- · Compatible with reflow soldering
- · Available in various color combination
- · Package: 2000 pcs / reel
- Moisture sensitivity level: 3
- Tinned pads for improved solderability
- RoHS compliant

APPLICATIONS

- Backlight
- · Status indicator
- Home and smart appliances
- · Wearable and portable devices
- · Healthcare applications

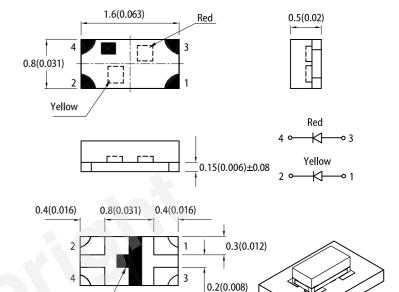
SELECTION GUIDE

ATTENTION

Observe precautions for handling electrostatic discharge sensitive devices



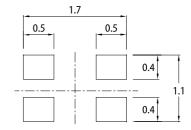
PACKAGE DIMENSIONS



RECOMMENDED SOLDERING PATTERN

Polarity Mark

(units: mm; tolerance: ± 0.1)



- 1. All dimensions are in millimeters (inches)
- Tolerance is ±0.15(0.006") unless otherwise noted.
 The specifications, characteristics and technical data described in the datasheet are subject to
- change without prior notice.

 4. The device has a single mounting surface. The device must be mounted according to the specifications.

Part Number	Emitting Color	Lens Type	lv (mcd) @ 20mA [2]		Viewing Angle [1]
r ait Number	(Material)	Lens Type	Min.	Тур.	201/2
	Super Bright Yellow		80	150	
KPHB-1608SYKSURKC-GX	(AlGainP)	Water Clear	*80	*150	130°
N TIB-10000 TNOONNO-OX	Hyper Red (AlGaInP)	vvater Glear	120	250	100
			*40	*90	

1. 61/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
2. Luminous intensity / luminous flux: +/-15%.

^{*} Luminous intensity value is traceable to CIE127-2007 standards.





ELECTRICAL / OPTICAL CHARACTERISTICS at T_A=25°C

Parameter	Symbol	Emitting Color	Va	lue	Unit
Farameter	Symbol	Emitting Color	Тур.	Max.	Uill
Wavelength at Peak Emission I _F = 20mA	λ_{peak}	Super Bright Yellow Hyper Red	590 645	-	nm
Dominant Wavelength I _F = 20mA	λ _{dom} ^[1]	Super Bright Yellow Hyper Red	590 630	-	nm
Spectral Bandwidth at 50% Φ REL MAX I _F = 20mA	Δλ	Super Bright Yellow Hyper Red	20 28	-	nm
Capacitance	С	Super Bright Yellow Hyper Red	20 35	-	pF
Forward Voltage I _F = 20mA	V _F ^[2]	Super Bright Yellow Hyper Red	2 1.95	2.5 2.5	V
Reverse Current (V _R = 5V)	I _R	Super Bright Yellow Hyper Red	-	10 10	uA

ABSOLUTE MAXIMUM RATINGS at T_A=25°C

Danamatan	Symbol	Value		
Parameter		Super Bright Yellow	Hyper Red	Unit
Power Dissipation	P _D	75	75	mW
Reverse Voltage	V _R	5	5	V
Junction Temperature	Tj	115 115		°C
Operating Temperature	T _{op}	-40 to	°C	
Storage Temperature	T _{stg}	-40 to +85		°C
DC Forward Current	I _F	30	30	mA
Peak Forward Current	I _{FM} ^[1]	175	185	mA
Electrostatic Discharge Threshold (HBM)	-	3000	3000	V

Notes:
1. 1/10 Duty Cycle, 0.1ms Pulse Width.
2. Relative humidity levels maintained between 40% and 60% in production area are recommended to avoid the build-up of static electricity – Ref JEDEC/JESD625-A and JEDEC/J-STD-033.



Notes.

1. The dominant wavelength (λd) above is the setup value of the sorting machine. (Tolerance λd: ±1nm.)

2. Forward voltage: ±0.1V.

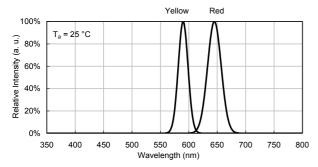
3. Wavelength value is traceable to CIE127-2007 standards.

4. Excess driving current and / or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

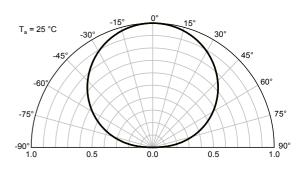


TECHNICAL DATA

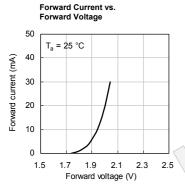
RELATIVE INTENSITY vs. WAVELENGTH

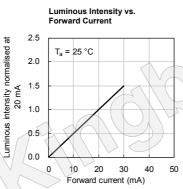


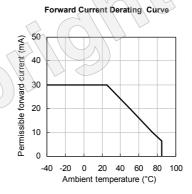
SPATIAL DISTRIBUTION

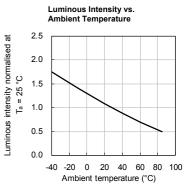


SUPER BRIGHT YELLOW

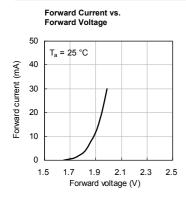


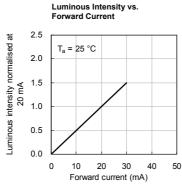


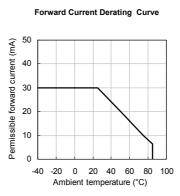


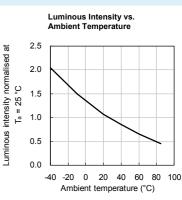


HYPER RED





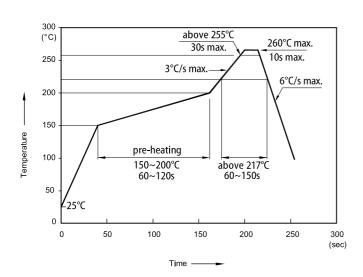






TECHNICAL DATA

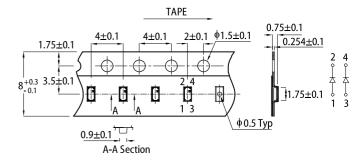
REFLOW SOLDERING PROFILE for LEAD-FREE SMD PROCESS



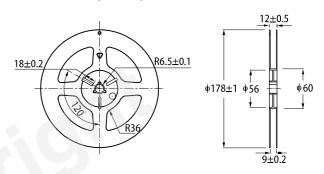
Notes

- Don't cause stress to the LEDs while it is exposed to high temperature.
- The maximum number of reflow soldering passes is 2 times.
 Reflow soldering is recommended. Other soldering methods cause damage to the product.

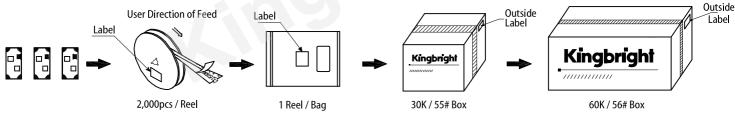
TAPE SPECIFICATIONS (units: mm)

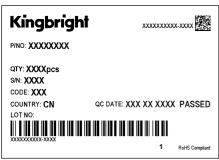


REEL DIMENSION (units:mm)



PACKING & LABEL SPECIFICATIONS





PRECAUTIONARY NOTES

- The information included in this document reflects representative usage scenarios and is intended for technical reference only.
- The part number, type, and specifications mentioned in this document are subject to future change and improvement without notice. Before production usage customer should refer to the latest datasheet for the updated specifications.
- When using the products referenced in this document, please make sure the product is being operated within the environmental and electrical limits specified in the datasheet. If
- customer usage exceeds the specified limits, Kingbright will not be responsible for any subsequent issues.

 The information in this document applies to typical usage in consumer electronics applications. If customer's application has special reliability requirements or have life-threatening liabilities, such as automotive or medical usage, please consult with Kingbright representative for further assistance.
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